

FEATURES

- Avalanche Rugged Technology
- Rugged Gate Oxide Technology
- Lower Input Capacitance
- Improved Gate Charge
- Extended Safe Operating Area
- 175°C Operating Temperature
- Lower Leakage Current : 10 μ A (Max.) @ $V_{DS} = 60V$
- Lower $R_{DS(on)}$: 0.020 Ω (Typ.)

$$BV_{DSS} = 60 V$$

$$R_{DS(on)} = 0.024 \Omega$$

$$I_D = 50 A$$

TO-220



1. Gate 2. Drain 3. Source

Absolute Maximum Ratings

Symbol	Characteristic	Value	Units
V_{DSS}	Drain-to-Source Voltage	60	V
I_D	Continuous Drain Current ($T_c=25^\circ C$)	50	A
	Continuous Drain Current ($T_c=100^\circ C$)	35.4	
I_{DM}	Drain Current-Pulsed ①	200	A
V_{GS}	Gate-to-Source Voltage	± 20	V
E_{AS}	Single Pulsed Avalanche Energy ②	857	mJ
I_{AR}	Avalanche Current ①	50	A
E_{AR}	Repetitive Avalanche Energy ①	12.6	mJ
dv/dt	Peak Diode Recovery dv/dt ③	5.5	V/ns
P_D	Total Power Dissipation ($T_c=25^\circ C$)	126	W
	Linear Derating Factor	0.84	W/ $^\circ C$
T_J, T_{STG}	Operating Junction and Storage Temperature Range	- 55 to +175	$^\circ C$
T_L	Maximum Lead Temp. for Soldering Purposes, 1/8 " from case for 5-seconds	300	

Thermal Resistance

Symbol	Characteristic	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	—	1.19	$^\circ C/W$
$R_{\theta CS}$	Case-to-Sink	0.5	—	
$R_{\theta JA}$	Junction-to-Ambient	—	62.5	

IRFZ44A

N-CHANNEL POWER MOSFET

Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
BV_{DSS}	Drain-Source Breakdown Voltage	60	—	—	V	$V_{GS}=0V, I_D=250\mu A$
$\Delta BV/\Delta T_J$	Breakdown Voltage Temp. Coeff.	—	0.063	—	V/ $^\circ\text{C}$	$I_D=250\mu A$ See Fig 7
$V_{GS(th)}$	Gate Threshold Voltage	2.0	—	4.0	V	$V_{DS}=5V, I_D=250\mu A$
I_{GSS}	Gate-Source Leakage, Forward	—	—	100	nA	$V_{GS}=20V$
	Gate-Source Leakage, Reverse	—	—	-100		$V_{GS}=-20V$
I_{DSS}	Drain-to-Source Leakage Current	—	—	10	μA	$V_{DS}=60V$
		—	—	100		$V_{DS}=48V, T_C=150^\circ\text{C}$
$R_{DS(on)}$	Static Drain-Source On-State Resistance	—	—	0.024	Ω	$V_{GS}=10V, I_D=25A$ ④
g_{fs}	Forward Transconductance	—	32.6	—	S	$V_{DS}=30V, I_D=25A$ ④
C_{iss}	Input Capacitance	—	1770	2300	pF	$V_{GS}=0V, V_{DS}=25V, f=1\text{MHz}$ See Fig 5
C_{oss}	Output Capacitance	—	590	680		
C_{rss}	Reverse Transfer Capacitance	—	220	255		
$t_{d(on)}$	Turn-On Delay Time	—	20	40	ns	$V_{DD}=30V, I_D=50A,$ $R_G=9.1\Omega$ See Fig 13 ④ ⑤
t_r	Rise Time	—	16	40		
$t_{d(off)}$	Turn-Off Delay Time	—	68	140		
t_f	Fall Time	—	70	140		
Q_g	Total Gate Charge	—	64	83	nC	$V_{DS}=48V, V_{GS}=10V,$ $I_D=50A$ See Fig 6 & Fig 12 ④ ⑤
Q_{gs}	Gate-Source Charge	—	12.3	—		
Q_{gd}	Gate-Drain("Miller ") Charge	—	23.6	—		

Source-Drain Diode Ratings and Characteristics

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
I_S	Continuous Source Current	—	—	50	A	Integral reverse pn-diode in the MOSFET
I_{SM}	Pulsed-Source Current ①	—	—	200		
V_{SD}	Diode Forward Voltage ④	—	—	1.8	V	$T_J=25^\circ\text{C}, I_S=50A, V_{GS}=0V$
t_{rr}	Reverse Recovery Time	—	85	—	ns	$T_J=25^\circ\text{C}, I_F=50A$
Q_{rr}	Reverse Recovery Charge	—	0.24	—	μC	$di_F/dt=100A/\mu s$ ④

Notes ;

- ① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- ② $L=0.4\text{mH}, I_{AS}=50A, V_{DD}=25V, R_G=27\Omega$, Starting $T_J=25^\circ\text{C}$
- ③ $I_{SD}\leq 50A, di/dt\leq 50A/\mu s, V_{DD}\leq BV_{DSS}$, Starting $T_J=25^\circ\text{C}$
- ④ Pulse Test : Pulse Width = 250 μs , Duty Cycle $\leq 2\%$
- ⑤ Essentially Independent of Operating Temperature

Fig 1. Output Characteristics

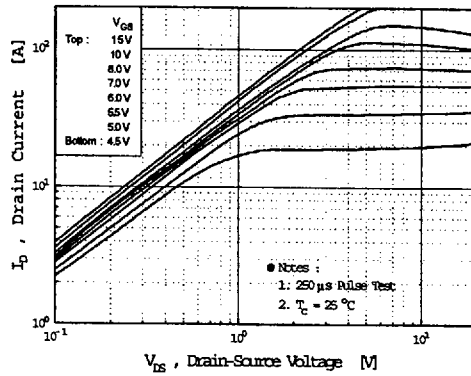


Fig 2. Transfer Characteristics

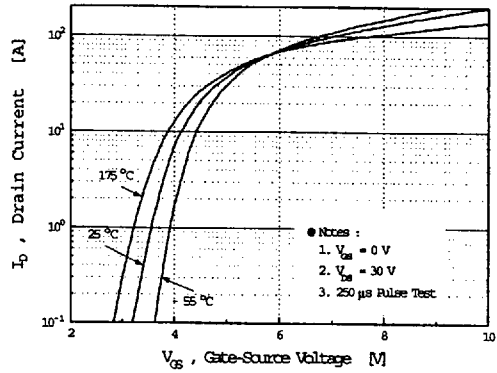


Fig 3. On-Resistance vs. Drain Current

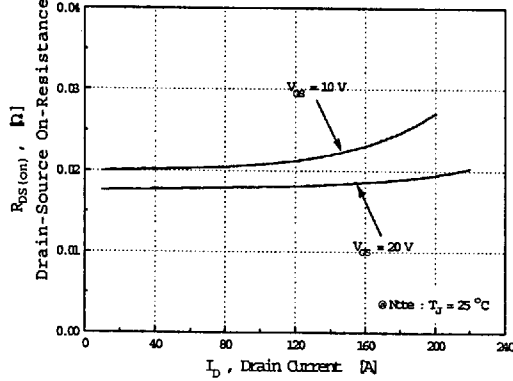


Fig 4. Source-Drain Diode Forward Voltage

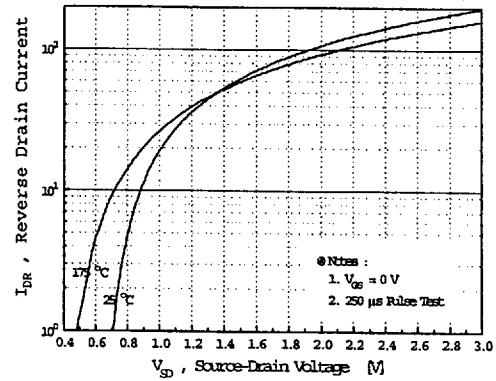


Fig 5. Capacitance vs. Drain-Source Voltage

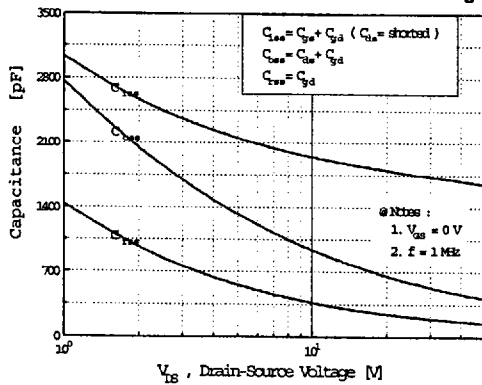
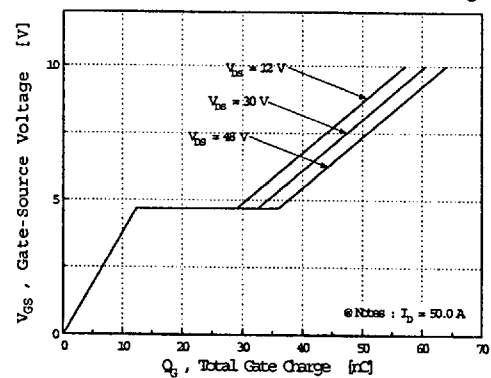


Fig 6. Gate Charge vs. Gate-Source Voltage



N-CHANNEL POWER MOSFET

Fig 7. Breakdown Voltage vs. Temperature

The graph shows the relationship between Breakdown Voltage (BV_{DS}) and Junction Temperature (T_J). The y-axis is labeled 'BV_{DS}, (Normalized) Drain-Source Breakdown Voltage' and ranges from 0.8 to 1.2. The x-axis is labeled 'T_J, Junction Temperature [°C]' and ranges from -75 to 200. A single data series is plotted as a solid line, showing a linear increase in breakdown voltage with temperature. The legend indicates the test conditions: V_{GS} = 0 V and I_D = 250 μA.

T _J , Junction Temperature [°C]	BV _{DS} , (Normalized) Drain-Source Breakdown Voltage
-50	0.91
0	0.96
25	1.00
50	1.03
75	1.06
100	1.09
125	1.12
150	1.15
175	1.18

A line graph showing the relationship between Normalized Drain-Source On-Resistance ($R_{DS(on)}$) and Junction Temperature (T_J). The y-axis is labeled $R_{DS(on)}, \text{ (Normalized)}$ and ranges from 0.5 to 2.5. The x-axis is labeled $T_J, \text{ Junction Temperature } [^{\circ}\text{C}]$ and ranges from -75 to 200. The curve shows that the on-resistance increases exponentially with temperature. Two notes are provided: 1. $V_{GS} = 10 \text{ V}$ and 2. $I_D = 25 \text{ A}$.

$T_J, \text{ Junction Temperature } [^{\circ}\text{C}]$	$R_{DS(on)}, \text{ (Normalized)}$
-50	0.75
0	0.90
50	1.10
100	1.40
150	1.80
175	2.10

Operation in This Area Is Limited by $R_{DS(on)}$

Notes :

1. $T_C = 25^\circ\text{C}$
2. $T_J = 175^\circ\text{C}$
3. Single Pulse

T_G [°C]	I_D [A]
25	50
50	48
75	42
100	35
125	22
150	10
175	0

Thermal Response $Z_{\theta c}(t)$

t_1 , Square Wave Pulse Duration [sec]

Notes:

1. $Z_{\theta c}(t) = 1.19^\circ\text{C/W Max.}$
2. Duty Factor, $D = t_1 / t_2$
3. $T_{MN} - T_C = P_{\text{DIN}} Z_{\theta c}(t)$

single pulse

Inset: Square wave pulse diagram showing peak P_m , duration t_1 , and period t_2 .

Fig 12. Gate Charge Test Circuit & Waveform

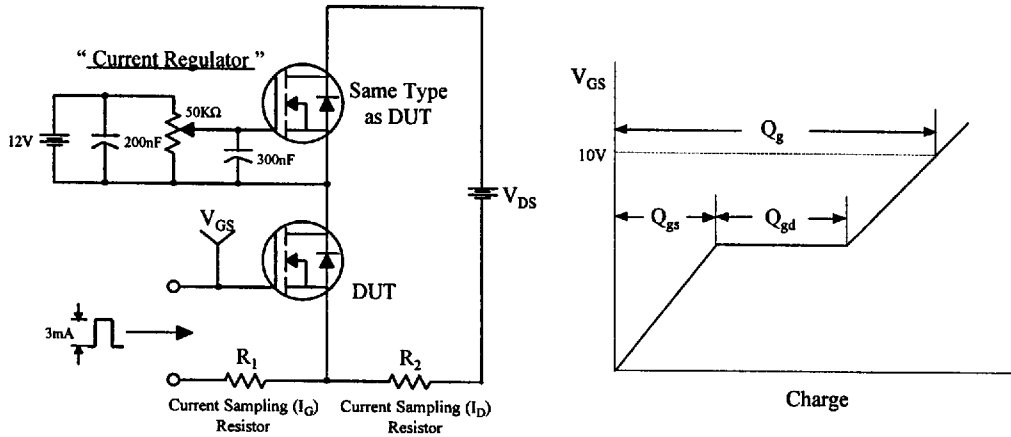


Fig 13. Resistive Switching Test Circuit & Waveforms

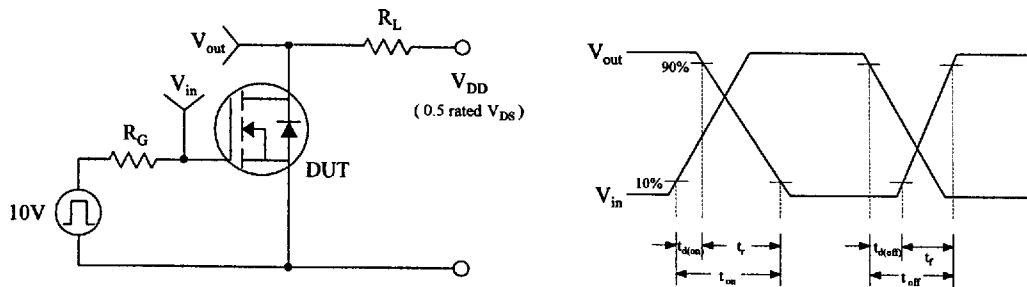


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

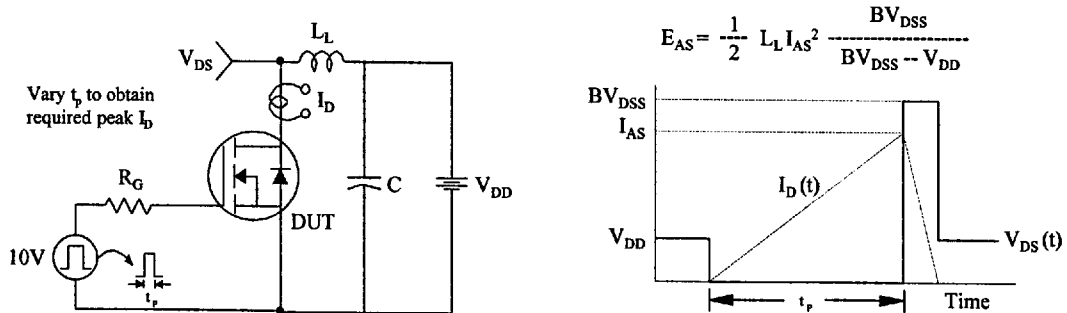
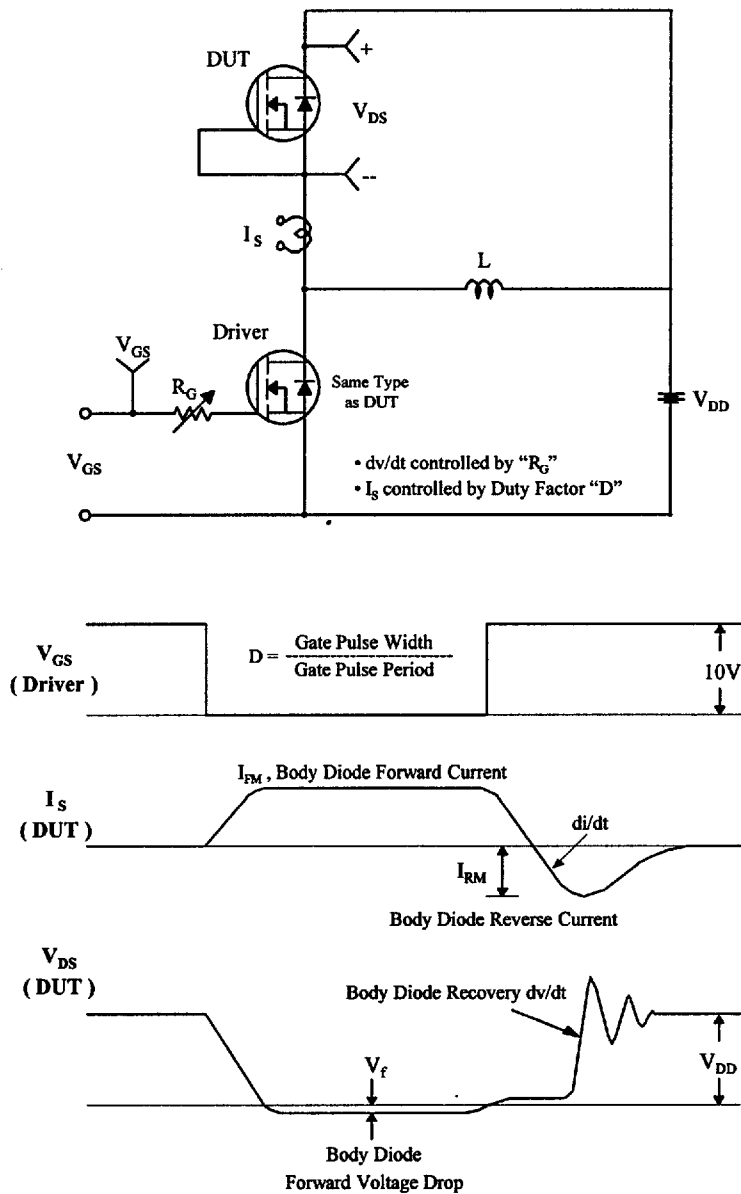
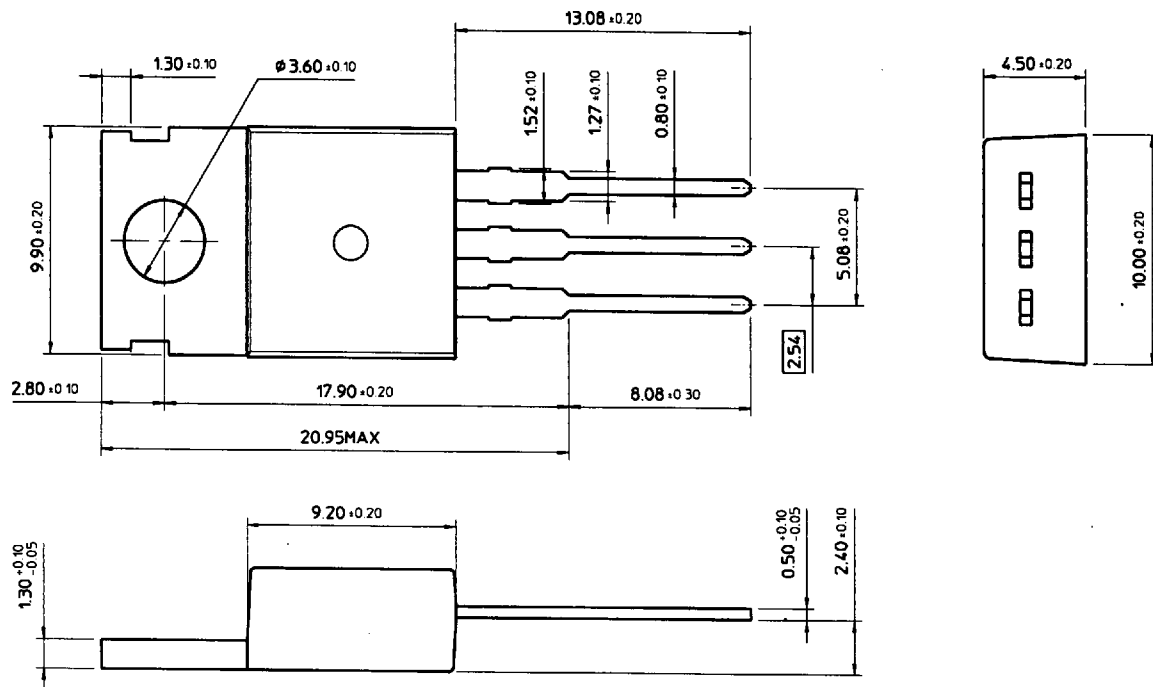


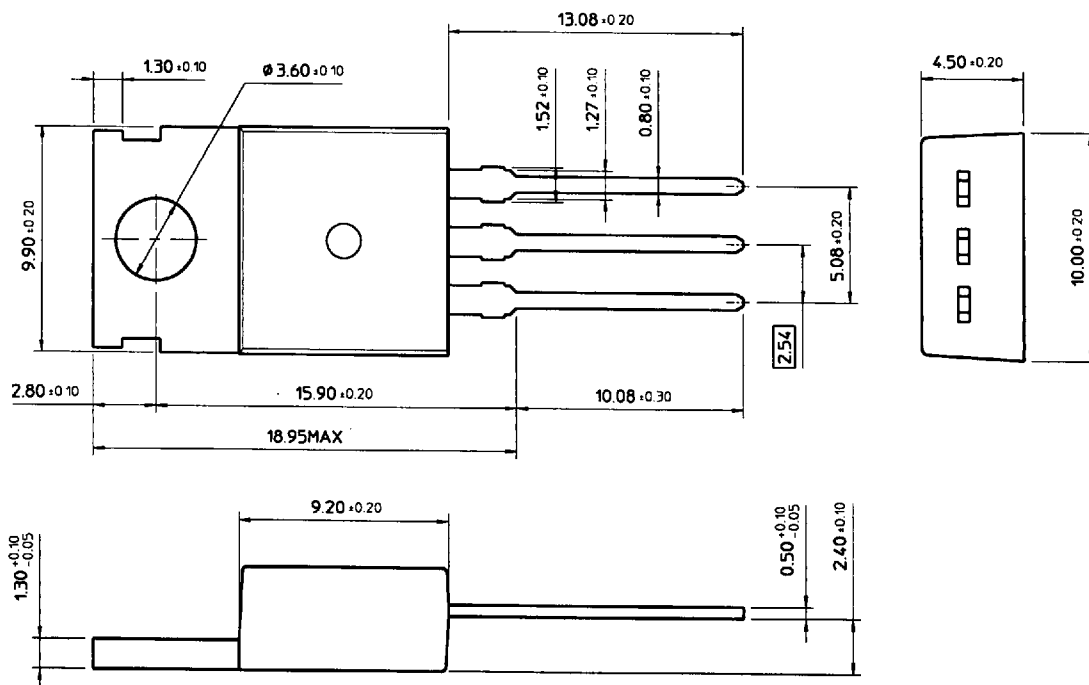
Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



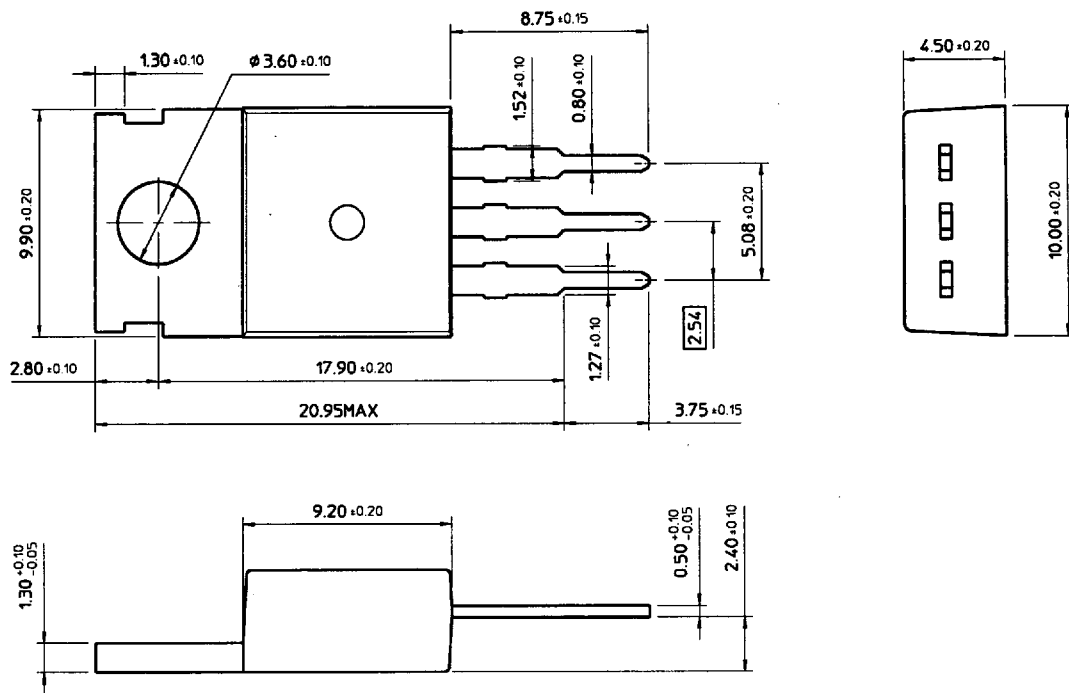
TO-220 (1)



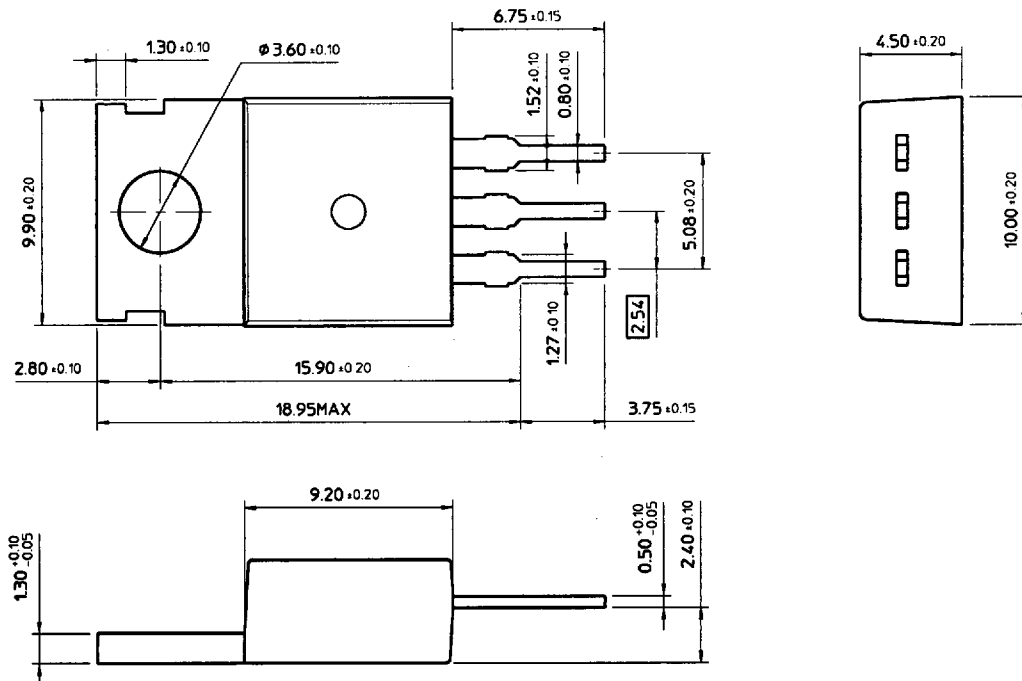
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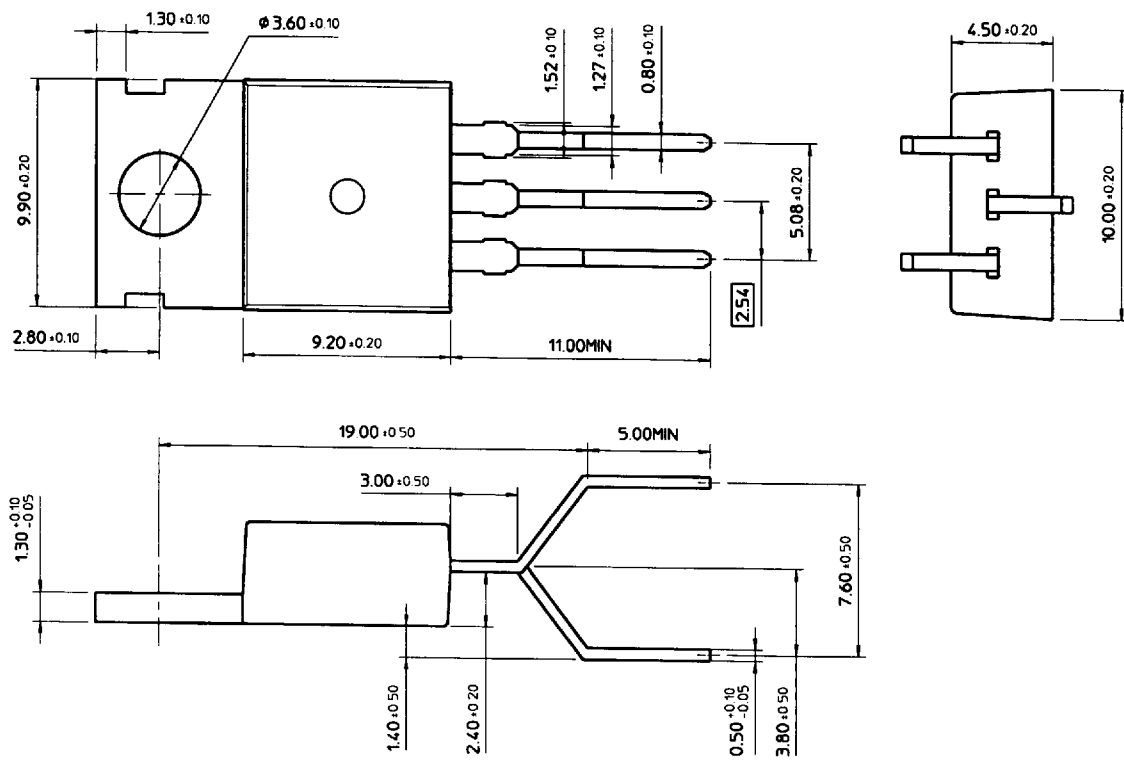
TO-220 (3)



TO-220 (4)



T0-220 (5)



NOTE